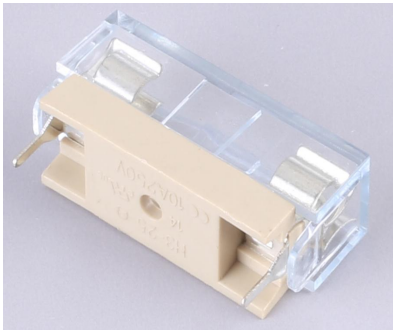
Hinew Electric Co., Ltd.

Fuseholder

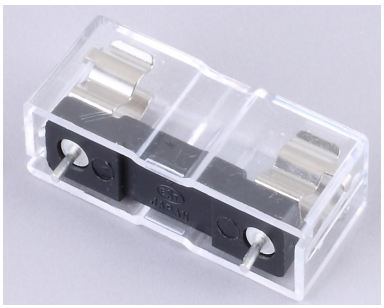
PCB mount

H3-25A/B(MF550)

Shock-Safe Fuseholder, 6.3 x 32 mm, Slot



H3-25A



H3-25B(MF550)

250VAC 2.5W/10A

Description

- Quick-conntect or solder terminals

References

Weblinks

pdf, General Product Information, Approvals, RoHS, CHINA-RoHS, e Store,

Standards

IEC60127-6

UL4248-1/UL512

GB9364.6

Approvals

- VDE Certificate Number: 134125

' UL File Number: E239034

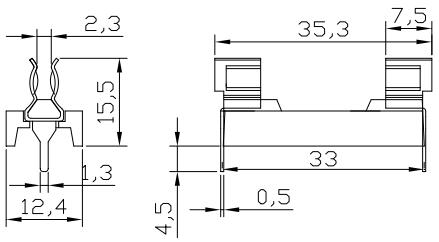
Technical Data

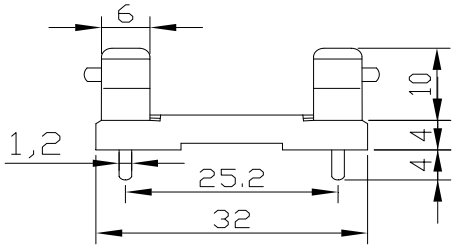
Shocksafe Category	PC2
Fuse-Link	6.3 x 32mm
Mounting	pcb board installation
Terminal	Solder
Rated Voltage	250VAC
Rated Current	10A (VDE), 10A (UL)
Rated Power Acceptance IE	2.5W / 10A @ Ta 23℃
	Admissible power acceptance at hig her ambient temperature see derating curves
Degree of Protection	IP 40
Protection Class	Suitable for appliances with protection class 1 or 2 acc. to IEC 61140
Admissible Ambient Air Tem	-40℃to85℃
Climatic Category	40/085/21 acc. to IEC 60068-1
Material: Socket	Thermoplastic, black, UL 94V-0
Material: Terminals	Tin-Plated Copper Alloy
Unit Weight (Socket/Cap)	6.39 g / 5.6 g
Storage Conditions	0℃ to 60℃, max. 70% r.h.
Product Marking	Type, Voltage, Current, Approvals

Soldering Methods	Soldering
Solderability	350℃ / 2sec acc. to IEC 60068-2-20, Test Ta, method 2
Resistance to Soldering Heat	350℃ / 10sec acc. to IEC 60068-2-20, Test Tb, method 2
Contact Resistance	< 5mΩ at 20 mV
Dielectric Strength	> 3kV between L-N > 4kV between L/N-PE (50Hz; 1 min)
Impulse Withstand Voltage	> 4kV between L-N > 6kV between L/N-PE
Insulation Resistance	> 10MΩ between L-N > 100MΩ between L/N-PE (500VDC; 1 min)
Overvoltage Category	I - III acc. to IEC 60664-1
Pollution Degree	1 - 3 acc. to IEC 60664-1
PCB board thickness	max3.5mm

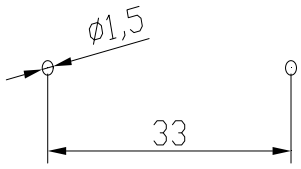
Hinew Electric Co., Ltd.

Abmessungen

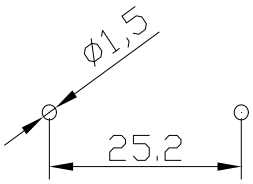




Mounting holes

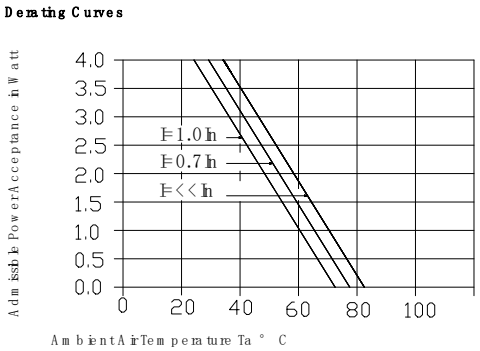


H3-25A



H3-25B(MF550)

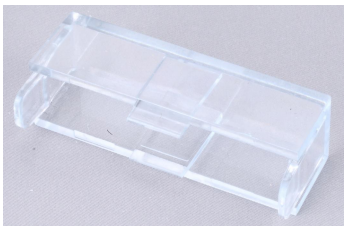
Derating Curves



Optional accessories

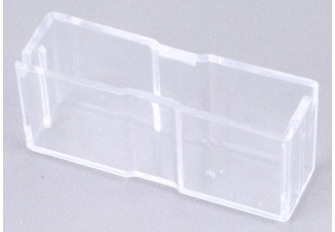
Description

25ATG



Snap-on head cover for H3-25A

25BTG



Snap-on head cover for H3-25B(MF550)